

1	2	3	4	5	6	7	8	9	10
SWITCH CIRCUIT			MATERIAL AND FINISH AS BELOW						
WHEN CARD IS EJECTED		WHEN CARD IS INSERTED	A Housing	LCP UL94V-0 Black			E		
			B Contact	Phosphor Bronze C5191, 0.15t, Contact Area:3u" Gold,Solder Area:Gold Flash			F		
			C Shell	SUS304 0.2t, Solder Area:Gold Flash			G		
						H			

**SPECIFICATION:**

**1. ELECTRICAL**

- 1.1 Current Rating: 1.0A
- 1.2 Voltage Rating: 30V AC/DC
- 1.3 Contact Resistance: 50mΩ
- 1.4 Insulation Resistance: 1000MΩ
- 1.5 Dielectric Withstanding Voltage: 500VDC

**2. MECHANICAL**

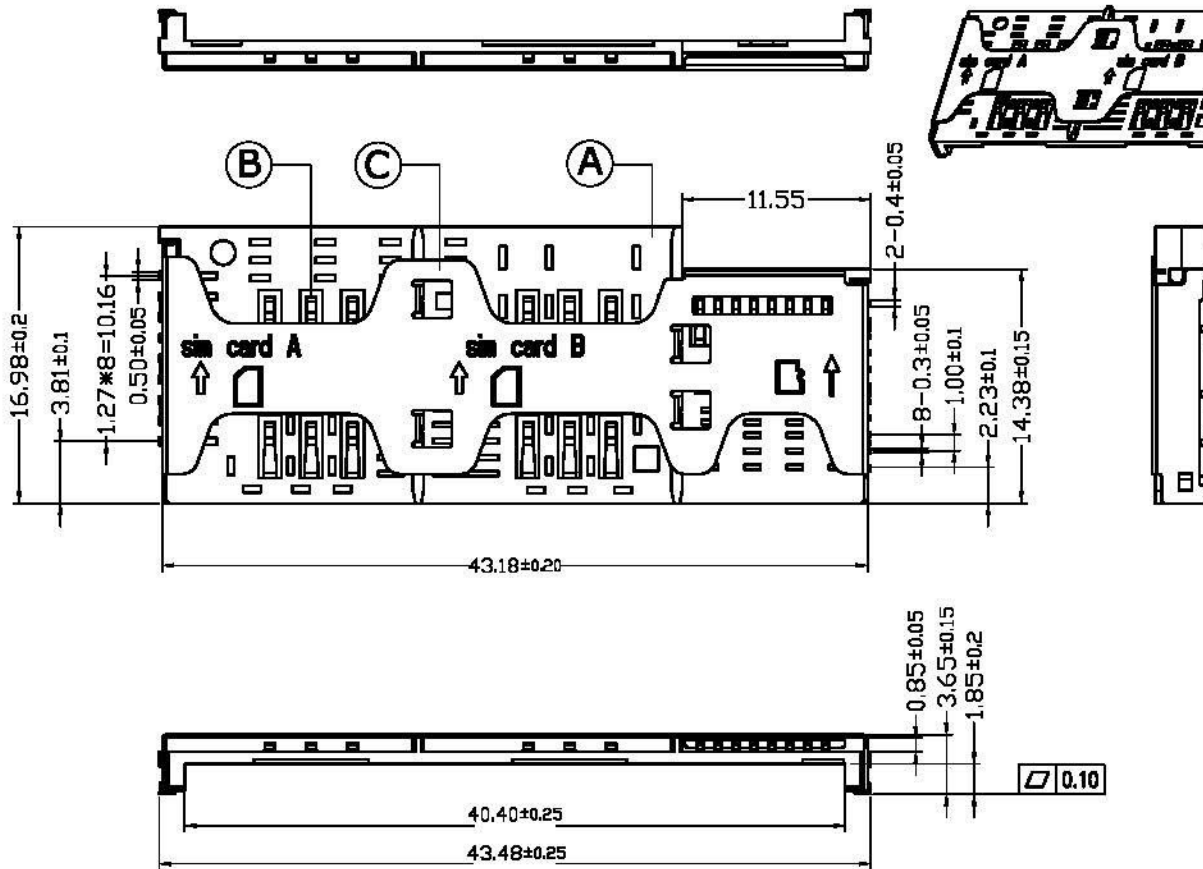
- 2.1 Durability: 10000 Cycle

**3. ENVIRONMENTAL**

- 3.1 Operating temperature range: -40°C~+85°C
- 3.2 Storage temperature range: -40°C~+85°C

**4. SOLDER ABILITY**

- 4.1 Recommended IR Reflow Temperature: 260°C



VCC	RST	CLK	GND	VPP	I/O					
C1	C2	C3	C5	C6	C7					

**PIN ASSIGNMENT**

<b>115M-AB360</b>	Dual SIM Card and Micro SD Socket , Contact Area:3u" Gold
<b>PRODUCT NO.</b>	<b>DESCRIPTION</b>

UNLESS OTHERWISE SPECIFIED TOLERANCE

ANGLES	ANG.	±5°
		±0.3
LINEAR		±0.25
		±0.20

SCALE AS SHOWN UNIT: mm

DRAWN	Willis	2013/09/24
CHECKED	Angel	2013/09/24
APPROVED	Ken	2013/09/24



www.allconnectors.com  
TEL: 0086 21 70606000 FAX: 0086 21 70606001  
2014-01-14 14:00:00 11/10/2013

**DRAWN NAME:**  
Dual SIM Card and Micro SD Socket

**PRODUCT NO.** 115M-AB360

REV.	DESCRIPTION	DATE	REV.	DESCRIPTION	DATE

